

STATIC CMOS RAMs, COMMERCIAL AND INDUSTRIAL TEMPERATURE RANGE

SIZE	DESCRIPTION	PART NUMBER	TAA (ns)	PACKAGES/PINS		
				P	J	S
1K	256x4	P93U422	35	22		24
1K	256x4	P4C422	10/12/15/25/35	22		24
4K	4Kx1 w/Separate I/O	P4C147	10/12/15/20/25	18		
4K	1Kx4 w/Common I/O	P4C148	10/12/15/20/25	18		
4K	1Kx4 w/Common I/O, Fast CS	P4C149	10/12/15/20/25	18		
4K	1Kx4 w/Separate I/O & Chip Clear	P4C150	10/12/15/20/25	24		24
16K	4Kx4 Common I/O	P4C168	10/12/15/20/25	20	20	20
16K	4Kx4 Common I/O w/Fast CS	P4C169	12/15/20/25	20		20
16K	4Kx4 Common I/O w/Fast CS & OE	P4C170	10/12/15/20/25	22	22	
16K	4Kx4 Separate I/O w/Transparent Write	P4C1681	10/12/15/20/25/35	24	24	24
16K	4Kx4 Separate I/O w/Tristate Write	P4C1682	10/12/15/20/25/35	24	24	24
16K	4Kx4 Cache-Tag (TP)	P4C180	10/12/15/20/25	22	24	
16K	4Kx4 Cache-Tag (OD)	P4C181	10/12/15/20/25	22	24	
16K	16Kx1	P4C167	10/12/15/20/25	20	20	
16K	2Kx8 Common I/O	P4C116	10/12/15/20/25/35	24	24	24
64K	64Kx1	P4C187	10/12/15/20	22	24	
64K	16Kx4 Common I/O	P4C188	15/20/25	22	24	
64K	16Kx4 w/OE	P4C198	15/20/25	24	24	
64K	16Kx4 w/OE & CE2	P4C198A	15/20/25	24		
64K	16Kx4 Separate I/O w/Transparent Write	P4C1981	15/20/25	28	28	
64K	16Kx4 Separate I/O w/Tristate Write	P4C1982	15/20/25	28	28	
64K	8Kx8	P4C164	10/12/15/20/25	28	28	
64K	8Kx8 Cache Tag (OD)	P4C174	10/12/15/20/25	28	28	
72K	8Kx9	P4C163	25/35	28	28	
256K	2x8Kx16 Latched Cache RAM	P4C214	13/17/20/25			52
240K	2x8Kx15 Bicameral RAM	P4C215	13/17/23			52
256K	16Kx16 Latched RAM	P4C218	13/15/20/25			52
256K	256Kx1	P4C1257	15/20/25		24	
256K	64Kx4	P4C194	15/20/25	24	24	
256K	64Kx4 with OE	P4C195	20/25	28	28	
256K	32Kx8	P4C1256	12/15/20/25/35	28	28	
1MEG	128Kx8	P4C1024	15/17/20/25/35	32	32	

P = Plastic Dip, J = SOJ, S = SOIC, PP = PLCC

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STATIC CMOS RAMS, MIL-STD-883 COMPLIANT PRODUCTS

SIZE	DESCRIPTION	PART NUMBER	TAA (ns)	D	PACKAGES/PINS		SR	F
					DW	L		
1K	256x4	P93U422	35	22		24		
1K	256x4	P4C422	15/25/35	22		24		
16K	4Kx4 w/Common I/O	P4C168	20/25/35	20				
16K	2Kx8 w/Common I/O	P4C116	20/25/35/45	24				
64K	64Kx1	P4C187	15/20/25/35	22		22		
64K	16Kx4 Common I/O	P4C188	20/25/35/45/55	22		22		
64K	16Kx4 W/OE	P4C198	20/25/35/45/55	24		28		
64K	16Kx4 W/OE & CE2	P4C198A	20/25/35/45/55	24				
64K	8Kx8	P4C164	20/25/35/45/55	28		28		
72K	8Kx9	P4C163	25/35/45/55	28		28		
256K	16Kx16 Latched RAM	P4C218	17/20/25				52	28

D = CERDIP  
 DW = 600 mil CERDIP  
 L = Leadless Chip Carrier, LCC  
 SR = Quad J-Lead Ceramic  
 F = Flatpack

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